XBS013S1CR-G is Discontinued. XBS013S1CR-G



Schottky Barrier Diode, 100mA, 30V Type

■FEATURES

Ultra Small Package

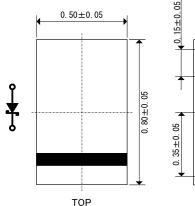
■ APPLICATIONS

Low Current Rectification

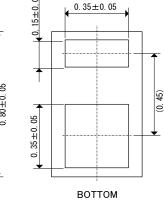
■ABSOLUTE MAXIMUM RATINGS

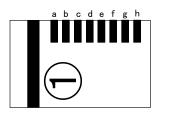
			Ta=25℃	
PARMETER	SYMBOL	RATINGS	UNITS	
Repetitive Peak Voltage	Vrm	30	V	
Reverse Voltage (DC)	Vr	30	V	
Forward Current (Average)	IF(AV)	100	mA	
Peak Forward Surge Current *1	IFSM	0.6	А	
Junction Temperature	Tj	125	°C	
Storage Temperature Range	Tstg	-55~+125	°C	

*1) 60Hz Half sine wave, 1 cycle, Non-Repetitive.



PACKAGING INFORMATION





MARKING RULE

① : 3(Product Number) a,b,c,d,e,d,e,f,g,h : Lot Number



Unit: mm

■PRODUCT NAME

PRODUCT NAME	PACKAGE
XBS013S1CR-G*	USP-2B02

^{*} The "-G" suffix indicates that the products are Halogen and Antimony free as well as being fully RoHS compliant. ^{*} The device orientation is fixed in its embossed tape pocket.

■ELECTRICAL CHARACTERISTICS

PARAMETER	SYMPOL	SYMBOL TEST CONDITIONS	LIMITS			UNITS
	STINDUL		MIN.	TYP.	MAX.	UNITS
Forward Voltage	VF1	I _F =100mA	-	0.71	1	V
Reverse Current	lr	V _R =25V	-	-	2	μA

•NOTES ON USE

1. Please keep away from mechanical stress to the product when mounting or after mounting.

2. If the IC is mounted close to a board break line or fixed in screws, the IC or its electrodes may be caused damage as results of board deformation and mechanical stress.

1/3

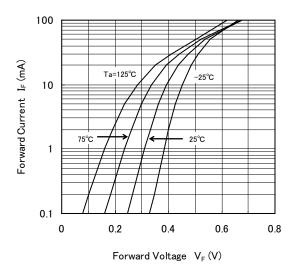
Ta=25°C

TYPICAL PERFORMANCE CHARACTERISTICS

(1) Forward Current vs. Forward Voltage

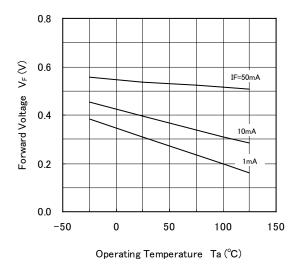
35 第

(2) Reverse Current vs. Reverse Voltage

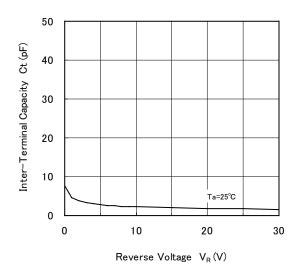


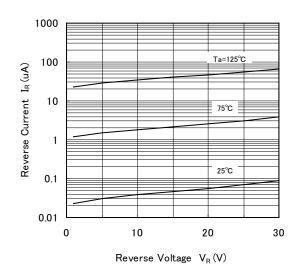
SOLESIORE

(3) Forward Voltage vs. Operating Temperature

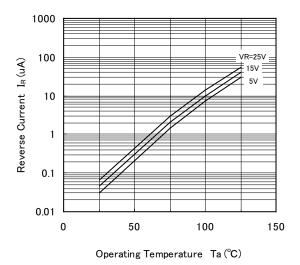


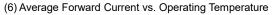
(5) Inter-Terminal Capacity vs. Reverse Voltage

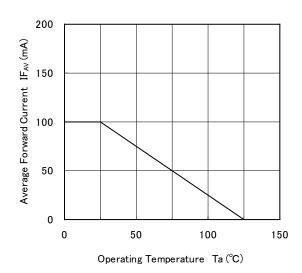




(4) Reverse Current vs. Operating Temperature







- 1. The products and product specifications contained herein are subject to change without notice to improve performance characteristics. Consult us, or our representatives before use, to confirm that the information in this datasheet is up to date.
- 2. We assume no responsibility for any infringement of patents, patent rights, or other rights arising from the use of any information and circuitry in this datasheet.
- 3. Please ensure suitable shipping controls (including fail-safe designs and aging protection) are in force for equipment employing products listed in this datasheet.
- 4. The products in this datasheet are not developed, designed, or approved for use with such equipment whose failure of malfunction can be reasonably expected to directly endanger the life of, or cause significant injury to, the user.
 - (e.g. Atomic energy; aerospace; transport; combustion and associated safety equipment thereof.)
- Please use the products listed in this datasheet within the specified ranges.
 Should you wish to use the products under conditions exceeding the specifications, please consult us or our representatives.
- 6. We assume no responsibility for damage or loss due to abnormal use.
- 7. All rights reserved. No part of this datasheet may be copied or reproduced without the prior permission of TOREX SEMICONDUCTOR LTD.

TOREX SEMICONDUCTOR LTD.